

THC63LVDM83R/THC63LVDM63R

REDUCED SWING LVDS 24Bit/18Bit COLOR HOST-LCD PANEL INTERFACE

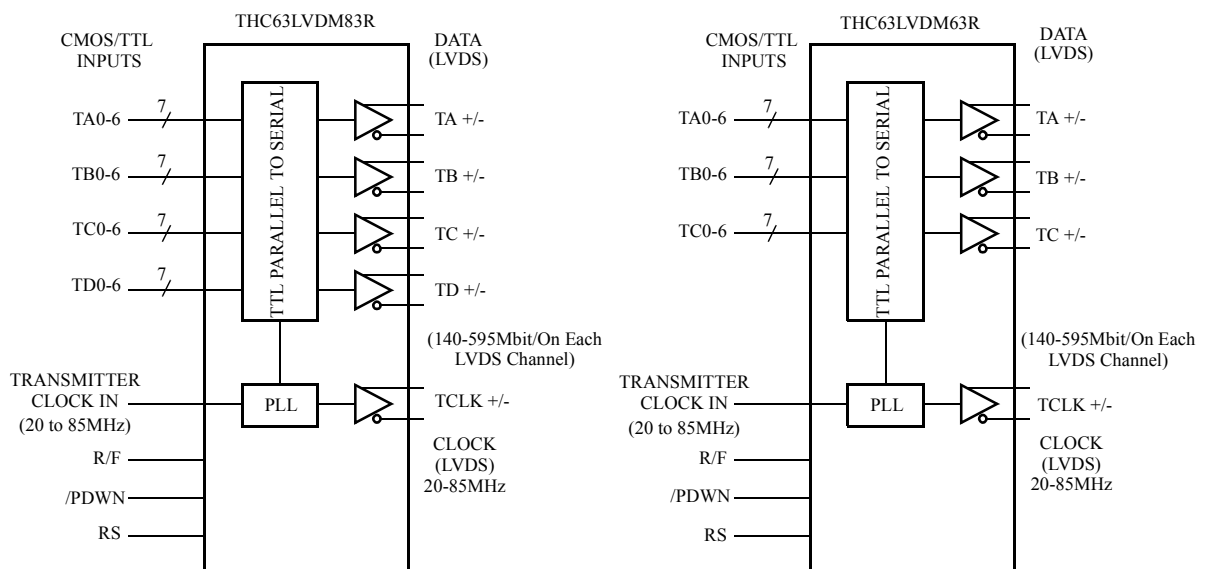
General Description

The THC63LVDM83R transmitter converts 28bits of CMOS/TTL data into LVDS (Low Voltage Differential Signaling) data stream. A phase-locked transmit clock is transmitted in parallel with the data streams over a fifth LVDS link. At a transmit clock frequency of 85MHz, 28bits of RGB data and 4bits of LCD timing and control data (HSYNC, VSYNC, CNTL1, CNTL2) are transmitted at a rate of 595Mbps per LVDS channel. Also available is THC63LVDM63R that converts 21bits of CMOS/TTL data into LVDS (Low Voltage Differential Signaling) data stream. Both transmitters can be programmed reduced swing LVDS through a dedicated pin for low power consumption and EMI.

Features

- 28:4 Data channel compression at up to 298 Megabytes per sec throughput
- Wide dot clock range: 20-85MHz suited for VGA, SVGA, XGA and SXGA
- Narrow bus (10 lines or 8 lines) reduces cable size
- Support Reduced swing LVDS for Low EMI
- 200mV swing LVDS/350mV swing LVDS selectable
- Support Spread Spectrum Clock Generator
- On chip Input Jitter Filtering
- PLL requires No external components
- Single 3.3V supply with 125mW(TYP)
- Power-Down Mode
- Low profile 56 or 48 Lead TSSOP Package
- Clock Edge Programmable
- Improved Replacement for the National DS90C383 or DS90C363

Block Diagram



Pin Out

THC63LVDM83R	
RS	1
TD1	2
TA5	3
TA6	4
GND	5
TB0	6
TB1	7
TD2	8
VCC	9
TD3	10
TB2	11
TB3	12
GND	13
TB4	14
TB5	15
TD4	16
R/F	17
TD5	18
TB6	19
TC0	20
GND	21
TC1	22
TC2	23
TC3	24
TD6	25
VCC	26
TC4	27
TC5	28
56	TA4
55	TA3
54	TA2
53	GND
52	TA1
51	TA0
50	TD0
49	LVDS GND
48	TA-
47	TA+
46	TB-
45	TB+
44	LVDS VCC
43	LVDS GND
42	TC-
41	TC+
40	TCLK-
39	TCLK+
38	TD-
37	TD+
36	LVDS GND
35	PLL GND
34	PLL VCC
33	PLL GND
32	/PDWN
31	CLK IN
30	TC6
29	GND

THC63LVDM63R	
TA4	1
RS	2
TA5	3
TA6	4
GND	5
TB0	6
TB1	7
VCC	8
TB2	9
TB3	10
GND	11
TB4	12
TB5	13
R/F	14
TB6	15
TC0	16
GND	17
TC1	18
TC2	19
TC3	20
VCC	21
TC4	22
TC5	23
GND	24
48	TA3
47	TA2
46	GND
45	TA1
44	TA0
43	N/C
42	LVDS GND
41	TA-
40	TA+
39	TB-
38	TB+
37	LVDS VCC
36	LVDS GND
35	TC-
34	TC+
33	TCLK-
32	TCLK+
31	LVDS GND
30	PLL GND
29	PLL VCC
28	PLL GND
27	/PDWN
26	CLK IN
25	TC6

THC63LVDM83R Pin Description

Pin Name	Pin #	Type	Description								
TA+, TA-	47, 48	LVDS OUT	LVDS Data Out.								
TB+, TB-	45, 46	LVDS OUT									
TC+, TC-	41, 42	LVDS OUT									
TD+, TD-	37, 38	LVDS OUT									
TCLK+, TCLK-	39, 40	LVDS OUT	LVDS Clock Out.								
TA0 ~ TA6	51, 52, 54, 55, 56, 3, 4	IN	Pixel Data Inputs.								
TB0 ~ TB6	6, 7, 11, 12, 14, 15, 19	IN									
TC0 ~ TC6	20, 22, 23, 24, 27, 28, 30	IN									
TD0 ~ TD6	50, 2, 8, 10, 16, 18, 25	IN									
/PDWN	32	IN	H: Normal operation, L: Power down (all outputs are Hi-Z)								
RS	1	IN	LVDS swing control. <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>RS</th> <th>LVDS swing</th> </tr> </thead> <tbody> <tr> <td>VCC</td> <td>350mV</td> </tr> <tr> <td>:</td> <td>:</td> </tr> <tr> <td>GND</td> <td>200mV</td> </tr> </tbody> </table>	RS	LVDS swing	VCC	350mV	:	:	GND	200mV
RS	LVDS swing										
VCC	350mV										
:	:										
GND	200mV										
R/F	17	IN	Input Clock Triggering Edge Select. H: Rising edge, L: Falling edge								
VCC	9, 26	Power	Power Supply Pins for TTL inputs and digital circuitry.								
CLKIN	31	IN	Clock in.								
GND	5, 13, 21, 29, 53	Ground	Ground Pins for TTL inputs and digital circuitry.								
LVDS VCC	44	Power	Power Supply Pins for LVDS Outputs.								
LVDS GND	36, 43, 49	Ground	Ground Pins for LVDS Outputs.								
PLL VCC	34	Power	Power Supply Pin for PLL circuitry.								
PLL GND	33, 35	Ground	Ground Pins for PLL circuitry.								

THC63LVDM63R Pin Description

Pin Name	Pin #	Type	Description								
TA+, TA-	40, 41	LVDS OUT	LVDS Data Out.								
TB+, TB-	38, 39	LVDS OUT									
TC+, TC-	34, 35	LVDS OUT									
TCLK+, TCLK-	32, 33	LVDS OUT	LVDS Clock Out.								
TA0 ~ TA6	44, 45, 47, 48, 1, 3, 4	IN	Pixel Data Inputs.								
TB0 ~ TB6	6, 7, 9, 10, 12, 13, 15	IN									
TC0 ~ TC6	16, 18, 19, 20, 22, 23, 25	IN									
/PDWN	27	IN	H: Normal operation, L: Power down (all outputs are Hi-Z)								
RS	2	IN	LVDS swing control. <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>RS</th> <th>LVDS swing</th> </tr> </thead> <tbody> <tr> <td>VCC</td> <td>350mV</td> </tr> <tr> <td>:</td> <td>:</td> </tr> <tr> <td>GND</td> <td>200mV</td> </tr> </tbody> </table>	RS	LVDS swing	VCC	350mV	:	:	GND	200mV
RS	LVDS swing										
VCC	350mV										
:	:										
GND	200mV										

Pin Name	Pin #	Type	Description
R/F	14	IN	Input Clock Triggering Edge Select. H: Rising edge, L: Falling edge
VCC	8, 21	Power	Power Supply Pins for TTL inputs and digital circuitry.
CLKIN	26	IN	Clock in.
GND	5, 11, 17, 24, 46	Ground	Ground Pins for TTL inputs and digital circuitry.
LVDS VCC	37	Power	Power Supply Pins for LVDS Outputs.
LVDS GND	36, 42	Ground	Ground Pins for LVDS Outputs.
PLL VCC	29	Power	Power Supply Pin for PLL circuitry.
PLL GND	28, 30	Ground	Ground Pins for PLL circuitry.

Absolute Maximum Ratings¹

Supply Voltage (V_{CC})	-0.3V ~ +4.0V
CMOS/TTL Input Voltage	-0.3V ~ ($V_{CC} + 0.3V$)
CMOS/TTL Output Voltage	-0.3V ~ ($V_{CC} + 0.3V$)
LVDS Driver Output Voltage	-0.3V ~ ($V_{CC} + 0.3V$)
Output Current	continuous
Junction Temperature	+125°C
Storage Temperature Range	-55°C ~ +150°C
Resistance to soldering heat	+260°C /10sec
Maximum Power Dissipation @+25°C	0.5W

Electrical Characteristics

CMOS/TTL DC Specifications

$V_{CC} = 3.0V \sim 3.6V$, $T_a = -10^\circ C \sim +70^\circ C$

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
V_{IH}	High Level Input Voltage		2.0		V_{CC}	V
V_{IL}	Low Level Input Voltage		GND		0.8	V
I_{IN}	Input Current	$0V \leq V_{IN} \leq V_{CC}$			± 10	μA
I_{PD}	Pull Down Current	R/F pin, $V_{IH} = V_{CC}$			100	μA
I_{RS}	RS Pull Down Current	RS pin, $V_{IH} = V_{CC}$			100	μA

1. "Absolute Maximum Ratings" are those valued beyond which the safety of the device can not be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.

LVDS Transmitter DC Specifications

 $V_{CC} = 3.0V \sim 3.6V, T_a = -10^{\circ}C \sim +70^{\circ}C$

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units	
VOD	Differential Output Voltage	RL=100Ω	Normal swing RS=V _{CC}	250	350	450	mV
			Reduced swing RS=GND	100	200	300	mV
ΔVOD	Change in VOD between complementary output states	RL=100Ω			35	mV	
VOC	Common Mode Voltage		1.125	1.25	1.375	V	
ΔVOC	Change in VOC between complementary output states				35	mV	
I _{OS}	Output Short Circuit Current	V _{OUT} =0V, RL=100Ω			-24	mA	
I _{OZ}	Output TRI-STATE Current	/PDWN=0V, V _{OUT} =0V to V _{CC}			±10	μA	

THC63LVDM83R Supply Current

 $V_{CC} = 3.0V \sim 3.6V, T_a = -10^{\circ}C \sim +70^{\circ}C$

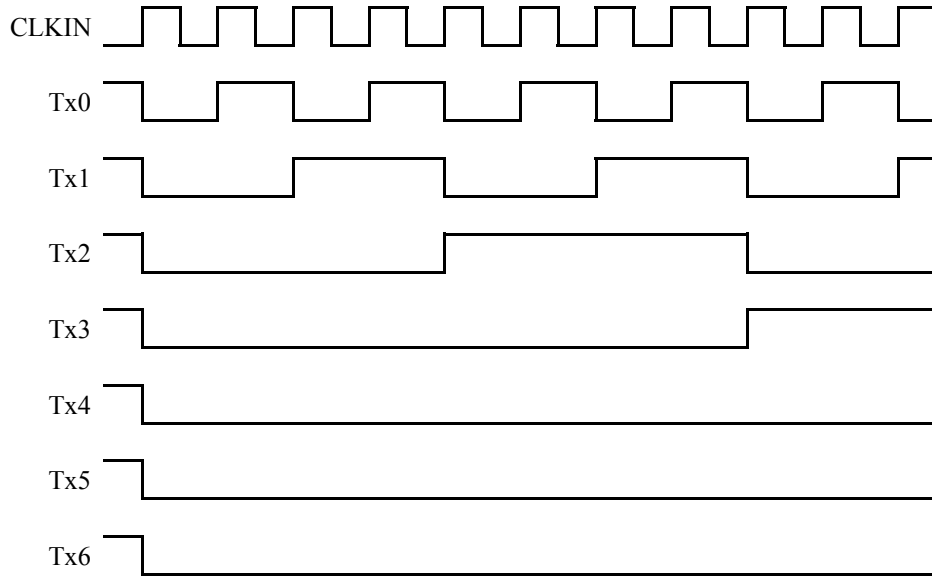
Symbol	Parameter	Condition(*)	Typ.	Max.	Units	
I _{TCCG}	Transmitter Supply Current	RL=100Ω, CL=5pF V _{CC} =3.3V, RS=V _{CC} 16 Gray Scale Pattern	f=65MHz	36	46	mA
			f=85MHz	39	49	mA
		RL=100Ω, CL=5pF V _{CC} =3.3V, RS=GND 16 Gray Scale Pattern	f=65MHz	31	41	mA
			f=85MHz	34	44	mA
I _{TCCW}	Transmitter Supply Current	RL=100Ω, CL=5pF V _{CC} =3.3V, RS=V _{CC} Worst Case Pattern	f=65MHz	38	48	mA
			f=85MHz	41	51	mA
		RL=100Ω, CL=5pF V _{CC} =3.3V, RS=GND Worst Case Pattern	f=65MHz	33	43	mA
			f=85MHz	36	46	mA
I _{TCCS}	Transmitter Power Down Supply Current	/PDWN = L		10	μA	

THC63LVDM63R Supply Current

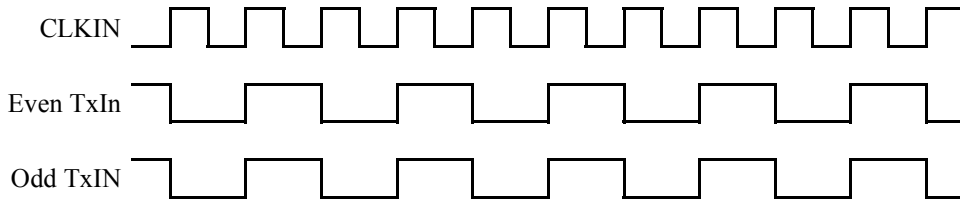
 $V_{CC} = 3.0V \sim 3.6V, T_a = -10^{\circ}C \sim +70^{\circ}C$

Symbol	Parameter	Condition(*)	Typ.	Max.	Units	
I _{TCCG}	Transmitter Supply Current	RL=100Ω, CL=5pF V _{CC} =3.3V, RS=V _{CC} 16 Gray Scale Pattern	f=65MHz	33	41	mA
			f=85MHz	37	45	mA
		RL=100Ω, CL=5pF V _{CC} =3.3V, RS=GND 16 Gray Scale Pattern	f=65MHz	29	36	mA
			f=85MHz	33	39	mA
I _{TCCW}	Transmitter Supply Current	RL=100Ω, CL=5pF V _{CC} =3.3V, RS=V _{CC} Worst Case Pattern	f=65MHz	35	43	mA
			f=85MHz	39	47	mA
		RL=100Ω, CL=5pF V _{CC} =3.3V, RS=GND Worst Case Pattern	f=65MHz	31	38	mA
			f=85MHz	35	42	mA
I _{TCCS}	Transmitter Power Down Supply Current	/PDWN = L		10	μA	

16 Gray Scale Pattern



Worst Case Pattern



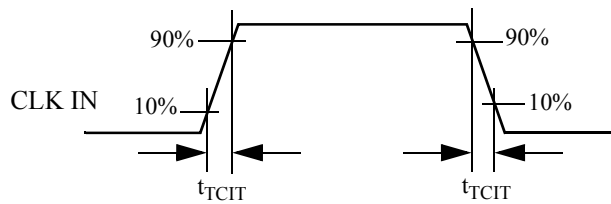
Switching Characteristics

V_{CC} = 3.0V ~ 3.6V, T_a = -10°C ~ +70°C

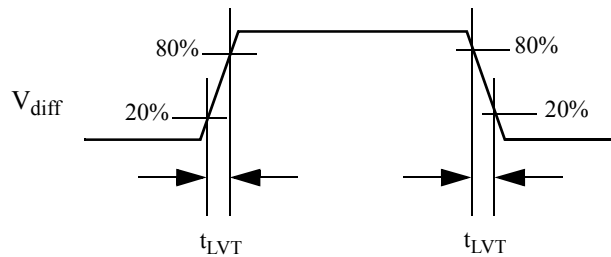
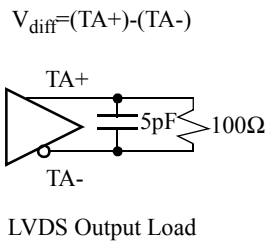
Symbol	Parameter	Min.	Typ.	Max.	Units
t _{TCIT}	CLK IN Transition time			5.0	ns
t _{TCP}	CLK IN Period	11.76	T	50.0	ns
t _{TCH}	CLK IN High Time	0.35T	0.5T	0.65T	ns
t _{TCL}	CLK IN Low Time	0.35T	0.5T	0.65T	ns
t _{TCD}	CLK IN to TCLK+/- Delay		2T/7		ns
t _{TS}	TTL Data Setup to CLK IN	2.5			ns
t _{TH}	TTL Data Hold from CKL IN	2.5			ns
t _{LVT}	LVDS Transition Time		0.6	1.5	ns
t _{TOP1}	Output Data Position0 (T=11.76ns)	-0.2	0.0	+0.2	ns
t _{TOP0}	Output Data Position1 (T=11.76ns)	$\frac{T}{7} - 0.2$	$\frac{T}{7}$	$\frac{T}{7} + 0.2$	ns
t _{TOP6}	Output Data Position2 (T=11.76ns)	$2\frac{T}{7} - 0.2$	$2\frac{T}{7}$	$2\frac{T}{7} + 0.2$	ns
t _{TOP5}	Output Data Position3 (T=11.76ns)	$3\frac{T}{7} - 0.2$	$3\frac{T}{7}$	$3\frac{T}{7} + 0.2$	ns
t _{TOP4}	Output Data Position4 (T=11.76ns)	$4\frac{T}{7} - 0.2$	$4\frac{T}{7}$	$4\frac{T}{7} + 0.2$	ns
t _{TOP3}	Output Data Position5 (T=11.76ns)	$5\frac{T}{7} - 0.2$	$5\frac{T}{7}$	$5\frac{T}{7} + 0.2$	ns
t _{TOP2}	Output Data Position6 (T=11.76ns)	$6\frac{T}{7} - 0.2$	$6\frac{T}{7}$	$6\frac{T}{7} + 0.2$	ns
t _{TPLL}	Phase Lock Loop Set			10.0	ms

AC Timing Diagrams

TTL Input

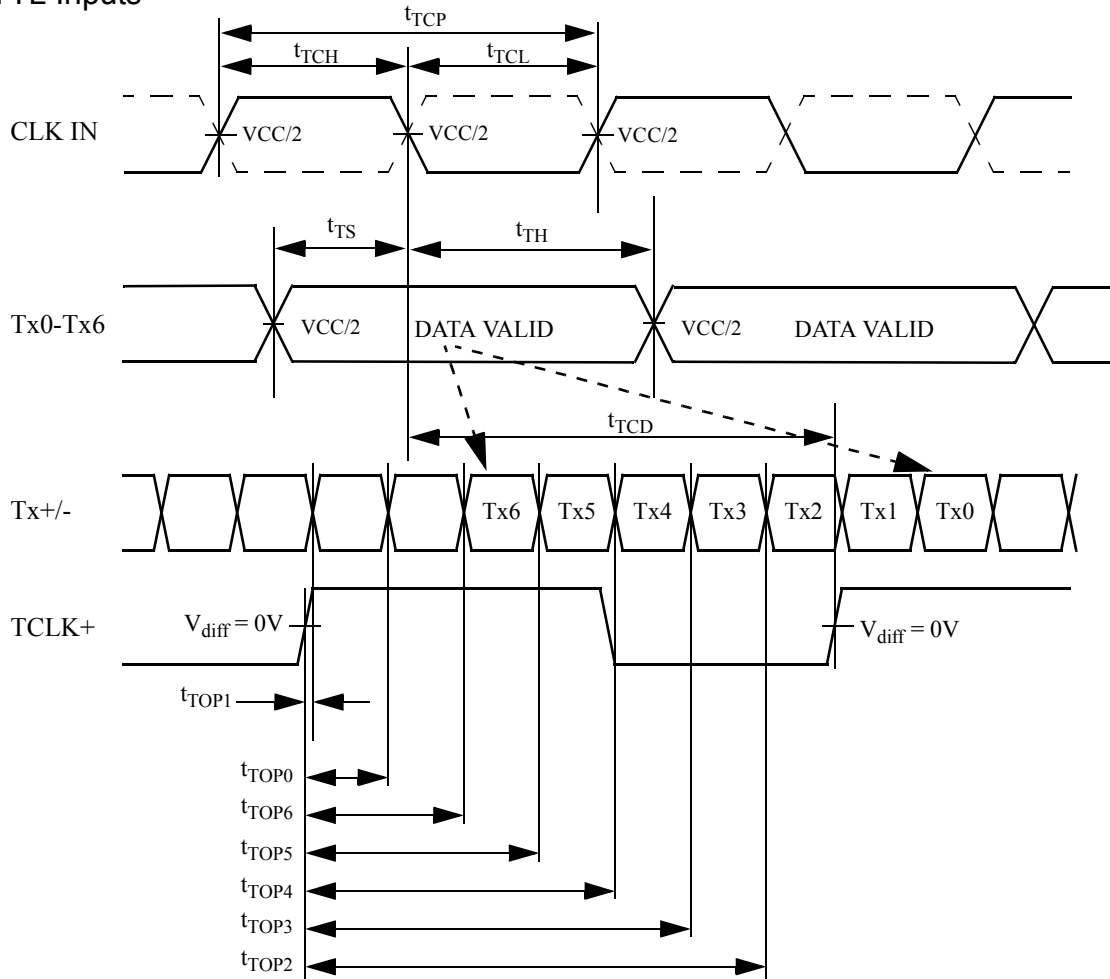


LVDS Output



AC Timing Diagrams

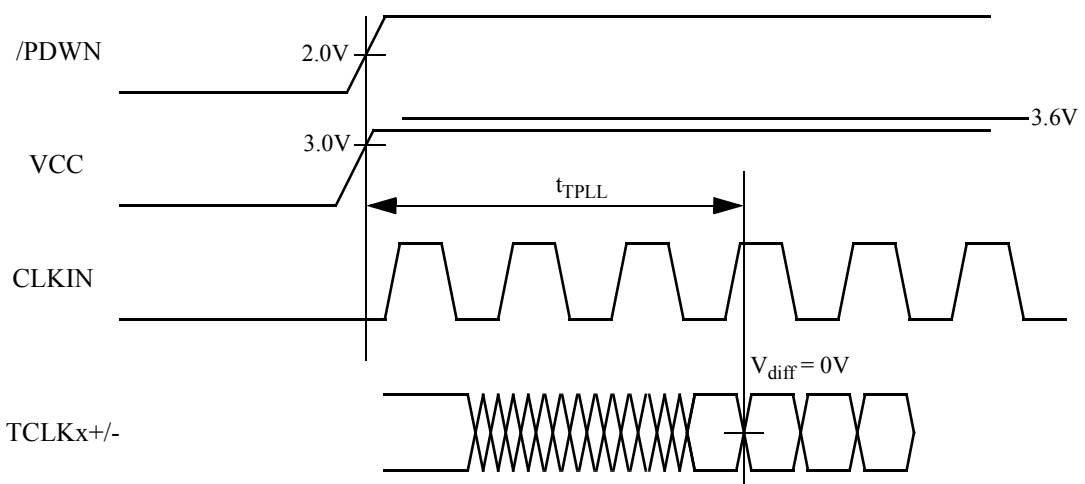
TTL Inputs



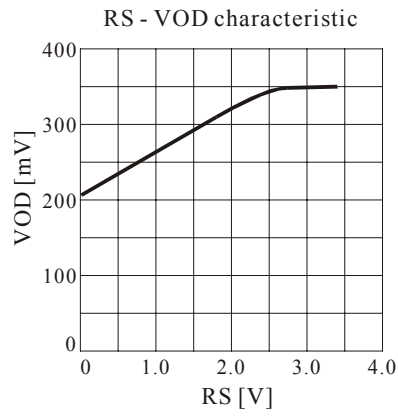
Note:

- 1) CLK IN: for THC63LVDM83R/THC63LVDM63R(R/F=GND), denote as solid line, for THC63LVDM83R/THC63LVDM63R(R/F=VCC), denote as dashed line
- 2) $V_{diff} = (T_{yx+}) - (T_{yx-})$, ---- (TCLKx+) - (TCLKx-)

Phase Lock Loop Set Time

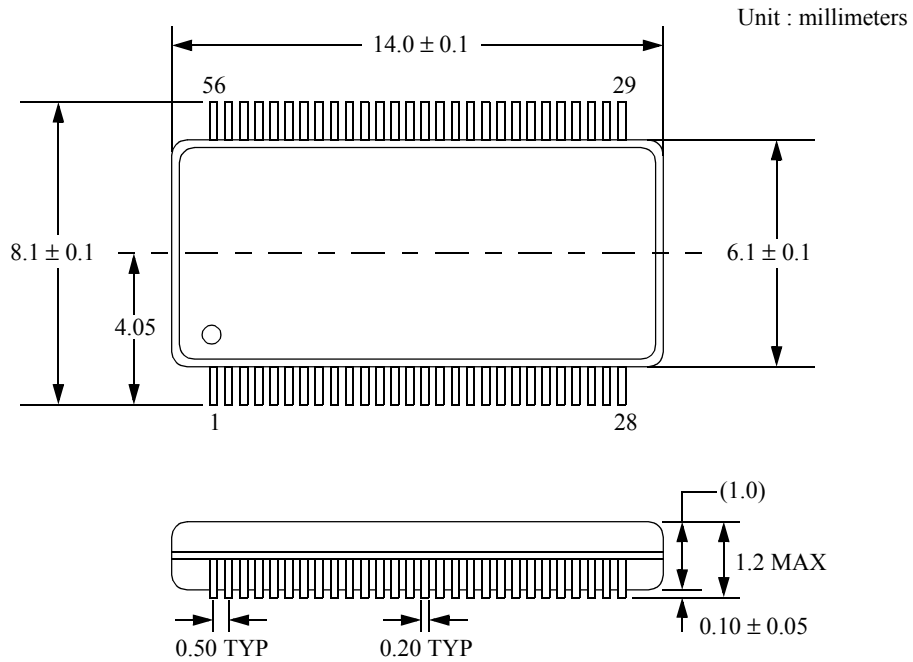


Reduced Swing Characteristic ($T_A=25^\circ\text{C}$, $V_{CC}=3.3\text{V}$, $R_L=100\Omega$)

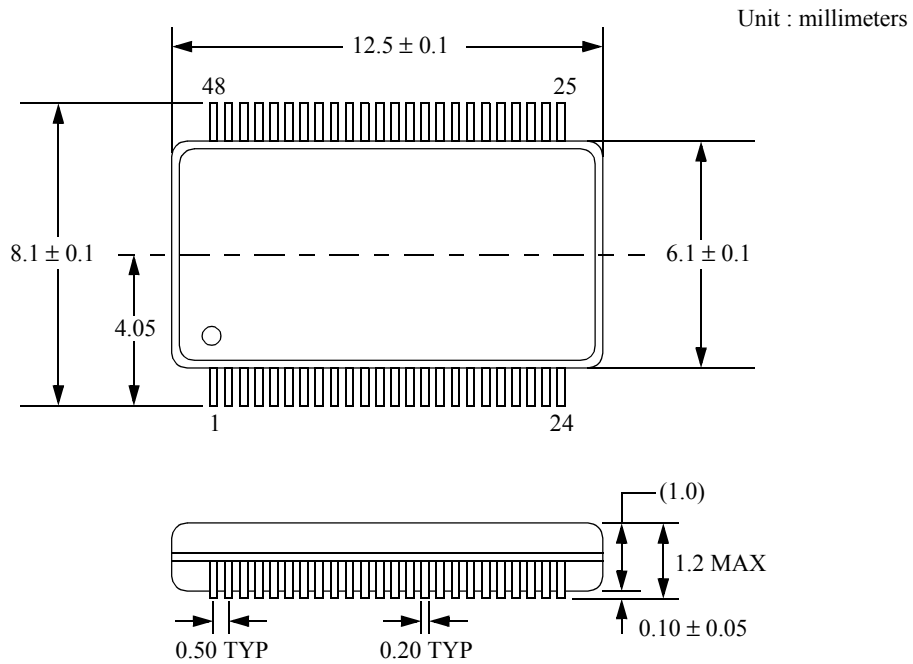


Package

56 Lead Molded Thin Shrink Small Outline Package, JEDEC



48 Lead Molded Thin Shrink Small Outline Package, JEDEC



Notes to Users:

1. The contents of this data sheet are subject to change without prior notice.
2. Circuit diagrams shown in this data sheet are examples of application. Therefore, please pay sufficient attention when designing circuits. Even if there are incorrect descriptions, we are not responsible for any problem due to them. Please note that incorrect descriptions sometimes cannot be corrected immediately if found.
3. Our copyright and know-how are included in this data sheet. Duplication of the data sheet and disclosure to other persons are strictly prohibited without our permission.
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5. We are making the utmost effort to improve the quality and reliability of our products. However, there is a very slight possibility of failure in semiconductor devices. To avoid damage to social or official organizations, much care should be taken to provide sufficient redundancy and fail-safe design.
6. No radiation-hardened design is incorporated in THC63LVDM83R/THC63LVDM63R.
7. Judgment on whether THC63LVDM83R/THC63LVDM63R comes under strategic products prescribed by the Foreign Exchange and Foreign Trade Control Law is the user's responsibility.
8. This technical document was provisionally created during development of THC63LVDM83R/THC63LVDM63R, so there is a possibility of differences between it and the product's final specifications. When designing circuits using THC63LVDM83R/THC63LVDM63R, be sure to refer to the final technical documents.

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